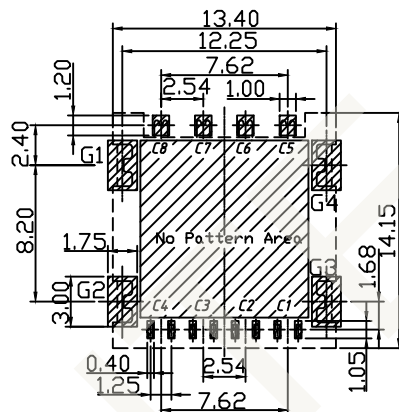
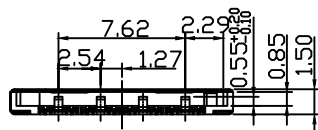
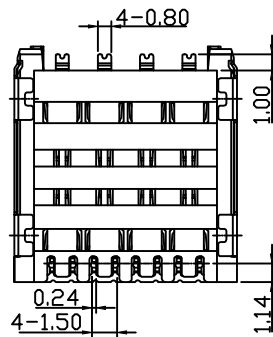
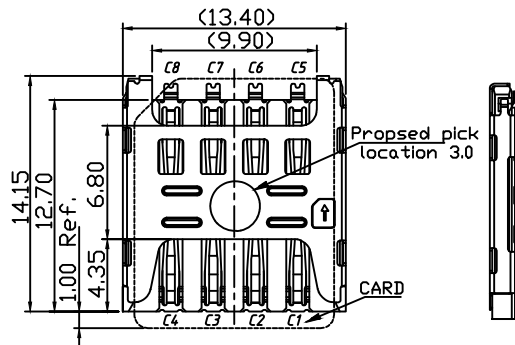
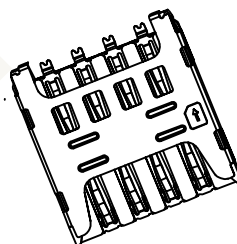
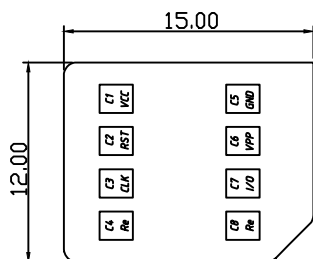




RECOMMENDED PCB LAYOUT(TOLERANCE±0.05)
RFCOMMFNDFD MATAI MASK T=0.12MM



Material

Housing:LCP,Black,UL94V-0.

Terminal:C5210R, 1u" Au;Solder:1u" Au;60u" Ni Plating

Cover:SUS304,1u" Au;30u" Ni Plating.

Electrical:

Rated Current:1.0A

Rated Voltage:30V

Contact Resistance:50mΩ Max.

Insulation Resistance:1000MΩ Min./500V DC

Dielectric Withstanding Voltage:500V AC

Solder ability:250℃±5℃,10±0.5s

Durability:3000 Cycles Min.Contact Resistance 50mΩ Max.

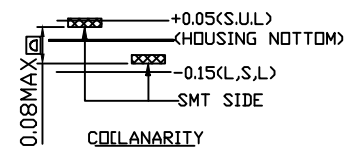
Operating condition: Temperature -40℃ TO +85℃

Humidity 80% R.H Max.

Mating and Unmating force:

Insertion Force 10N Max.

Withdrawal Force 10N Max.



SIM Card

Pin NO	Description
C1	VCC(Supply Voltage)
C2	RST(Reset Signal)
C3	CLK(Clock Signal)
C4	Reserved
C5	GND
C6	VPP(Variable Supply Vlotage)
C7	I/O(Data Input/Output)
C8	Reserved
G1-G4	GND



NINGBO RHT ELECTRONIC CO.,LTD

UNITS:mm SHEET SIZE: A4 SCALE:---

0~3 3~18 18~50 50~120

±0.12 ±0.15 ±0.3 ±0.5

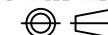
DRWN BY PAN

CHK'D BY FENG

APPR BY ZHAN

Micro SIM CONN;PUSH/PULL,8PIN,H1.5mm

THIRD ANGLE PROJECTION



RHTAYIM-091-8P-H1.5-R